NPN 5 GHz wideband transistor

Rev. 1 — 29 October 2010

Product data sheet

1. Product profile

1.1 General description

Silicon NPN transistor encapsulated in a plastic SOT323 (S-mini) package. The BFR94AW uses the same crystal as the SOT23 version, BFR94A.

1.2 Features and benefits

- High power gain
- Gold metallization ensures excellent reliability
- AEC-Q101 qualified

1.3 Applications

RF amplifiers, mixers and oscillators with signal frequencies up to 1 GHz

1.4 Quick reference data

Table 1. Quick reference data

Table 1.	Quick reference data					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CBO}	collector-base voltage	open emitter	-	-	20	V
V _{CEO}	collector-emitter voltage	open base	-	-	15	V
I _C	collector current		-	-	25	mA
P _{tot}	total power dissipation	$T_{sp} \le 93 \ ^{\circ}C$	-	-	300	mW
h _{FE}	DC current gain	I_{C} = 15 mA; V_{CE} = 10 V	65	90	135	
C _{re}	feedback capacitance	$I_C = 0 \text{ mA}; V_{CE} = 10 \text{ V};$ f = 1 MHz; T _{amb} = 25 °C	-	0.35	-	pF
f _T	transition frequency	I _C = 15 mA; V _{CE} = 10 V; f = 500 MHz	3.5	5	-	GHz
G _{UM}	unilateral power gain	I_C = 15 mA; V_{CE} = 10 V; T_{amb} = 25 °C				
		f = 1 GHz	-	14	-	dB
		f = 2 GHz	-	8	-	dB
NF	noise figure	$I_C = 5 \text{ mA}; V_{CE} = 10 \text{ V};$ f = 1 GHz; $\Gamma_S = \Gamma_{opt}$	-	2	-	dB
Tj	junction temperature		-	-	150	°C



2. Pinning information

Table 2.	Pinning		
Pin	Description	Simplified outline	Graphic symbol
1	base		
2	emitter		3
3	collector	1 2	2
			sym026

3. Ordering information

Table 3.Order	ring inform	ation	
Type number	Package		
	Name	Description	Version
BFR94AW	-	plastic surface-mounted package; 3 leads	SOT323

4. Marking

Table 4. Marking		
Type number	Marking code	Description
BFR94AW	XG*	* = p : made in Hong Kong
		* = t : made in Malaysia

5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

	Parameter	Conditions	Min	Max	Unit
V _{CBO}	collector-base voltage	open emitter	-	20	V
V_{CEO}	collector-emitter voltage	open base	-	15	V
V_{EBO}	emitter-base voltage	open collector	-	2	V
I _C	collector current		-	25	mA
P _{tot}	total power dissipation	$T_{sp} \le 93 \text{ °C}$; see Figure 1	<u>[1]</u> _	300	mW
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		-	+150	°C

[1] T_{sp} is the temperature at the solder point of the collector pin.

6. Thermal characteristics

Table 6.	Thermal characteristics			
Symbol	Parameter	Conditions	Тур	Unit
R _{th(j-sp)}	thermal resistance from junction to solder point	$T_{sp} \le 93 \ ^{\circ}C$	<u>[1]</u> 190	K/W

[1] T_{sp} is the temperature at the solder point of the collector pin.

7. Characteristics

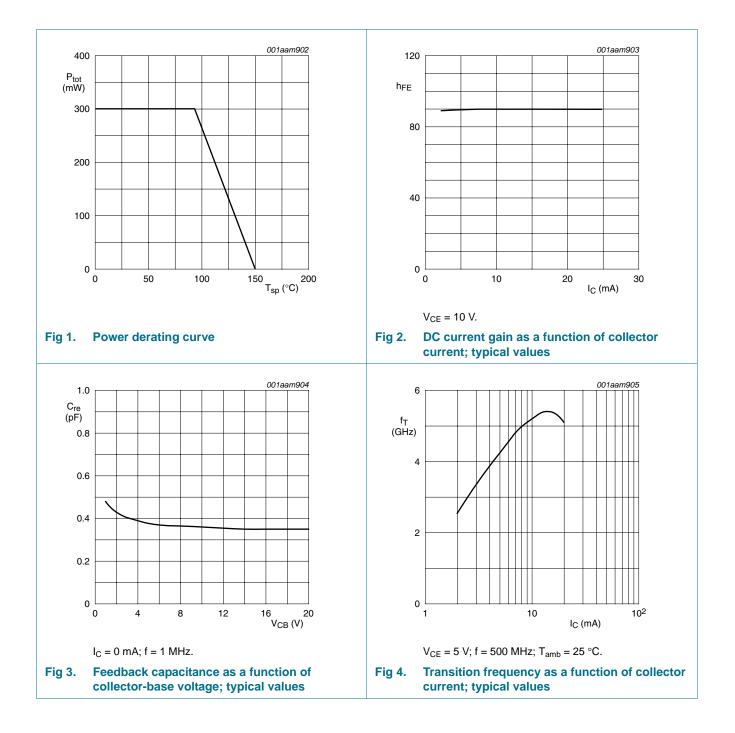
Table 7.	Characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _{CBO}	collector-base cut-off current	I _E = 0 A; V _{CB} = 10 V	-	-	50	nA
h _{FE}	DC current gain	$I_{C} = 15 \text{ mA}; V_{CE} = 10 \text{ V}$	65	90	135	
Cc	collector capacitance	$I_E = i_e = 0 \text{ A}; V_{CB} = 10 \text{ V}; f = 1 \text{ MHz}$	-	0.6	-	pF
Ce	emitter capacitance	$I_C = i_c = 0$ A; $V_{EB} = 0.5$ V; f = 1 MHz	-	0.9	-	pF
C _{re}	feedback capacitance	$I_C = 0 \text{ mA}; V_{CE} = 10 \text{ V}; \text{ f} = 1 \text{ MHz};$ $T_{amb} = 25 \text{ °C}$	-	0.35	-	pF
f _T	transition frequency	I_{C} = 15 mA; V_{CE} = 10 V; f = 500 MHz	3.5	5	-	GHz
G _{UM}	unilateral power gain	I_C = 15 mA; V_{CE} = 10 V; T_{amb} = 25 °C	<u>[1]</u>			
		f = 1 GHz	-	14	-	dB
		f = 2 GHz	-	8	-	dB
NF	noise figure	I_C = 5 mA; V_{CE} = 10 V; Γ_S = Γ_{opt}				
		f = 1 GHz	-	2	-	dB
		f = 2 GHz	-	3	-	dB

[1] G_{UM} is the maximum unilateral power gain, assuming S_{12} is zero and

$$G_{UM} = 10 \log \frac{|S_{2I}|^2}{(1 - |S_{1I}|^2)(1 - |S_{22}|^2)} dB.$$

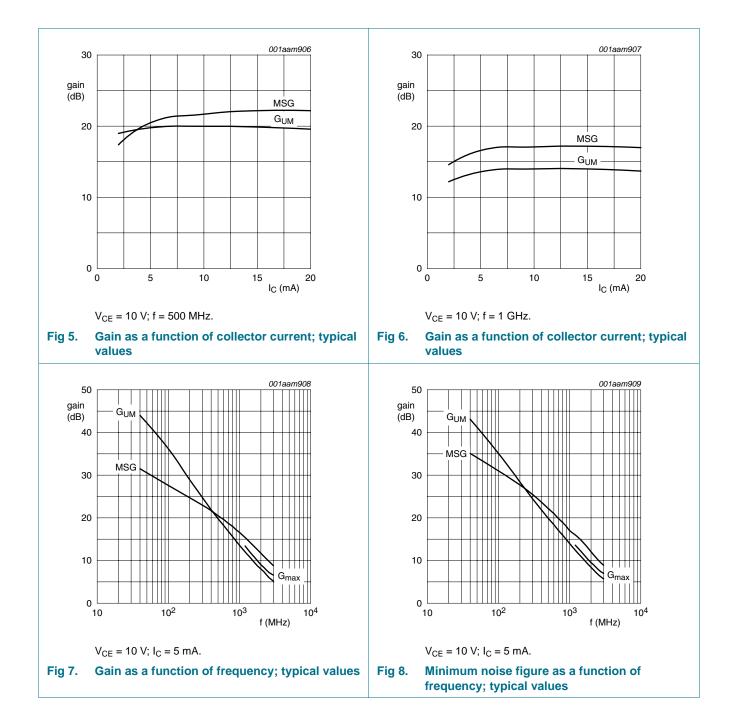
BFR94AW

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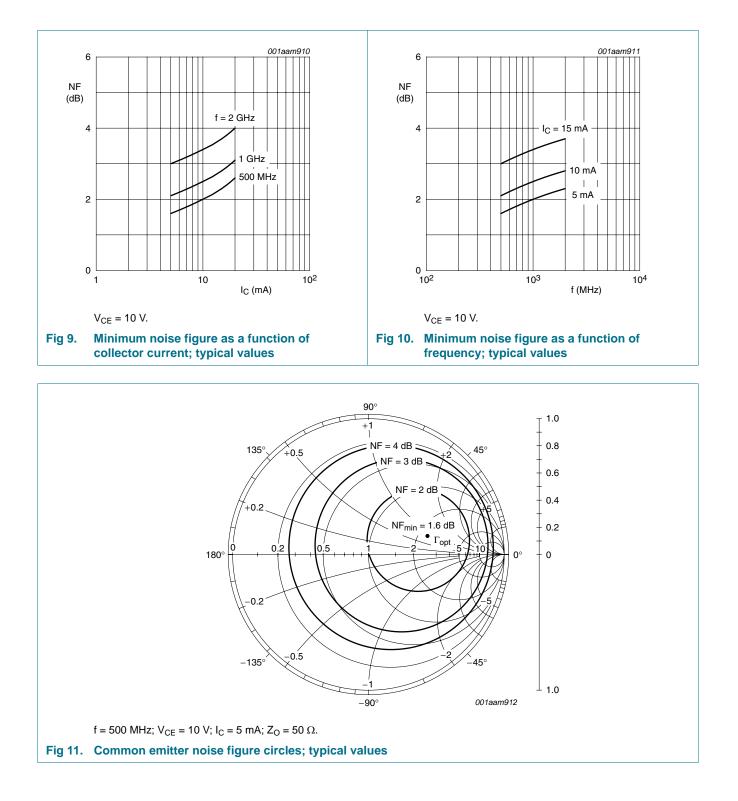
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BFR94AW

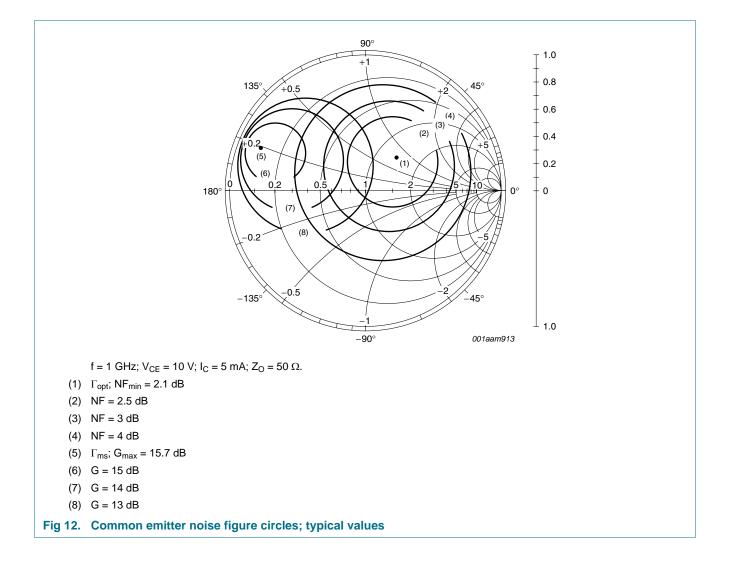
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Product data sheet

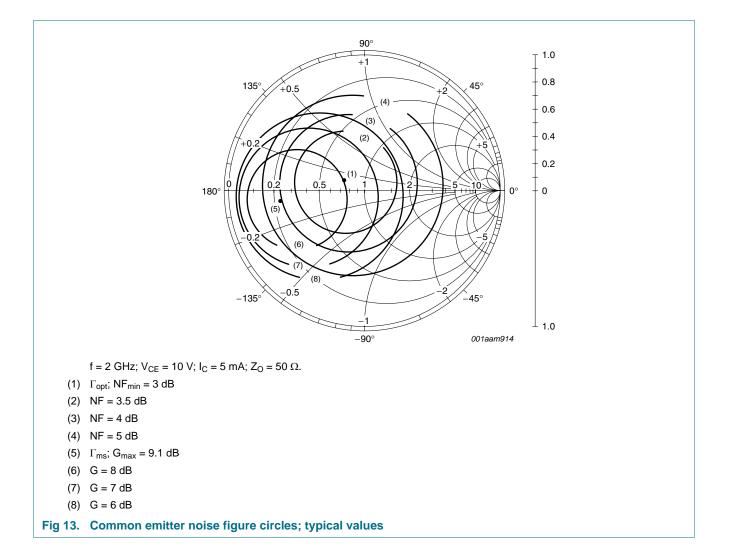
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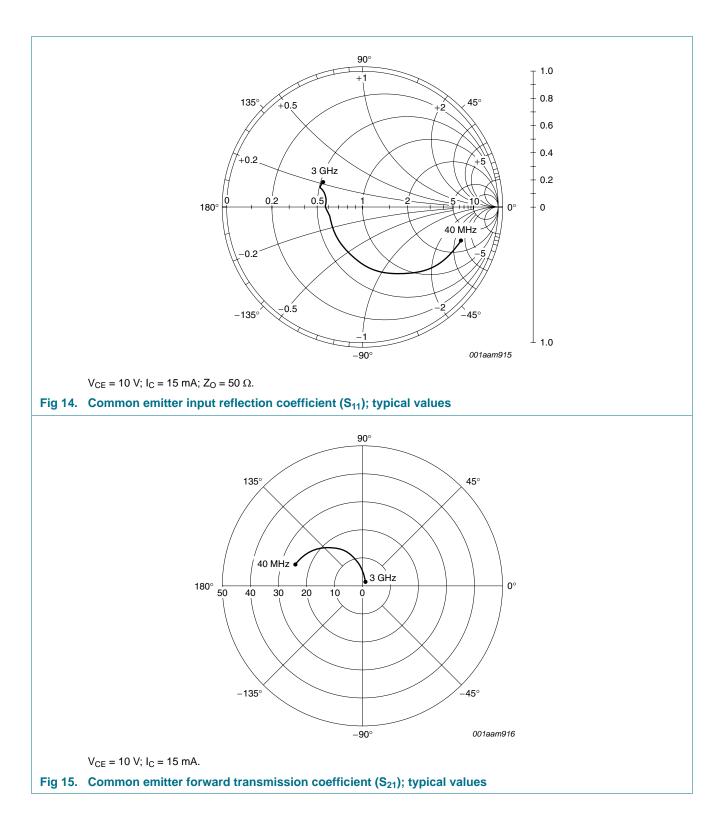
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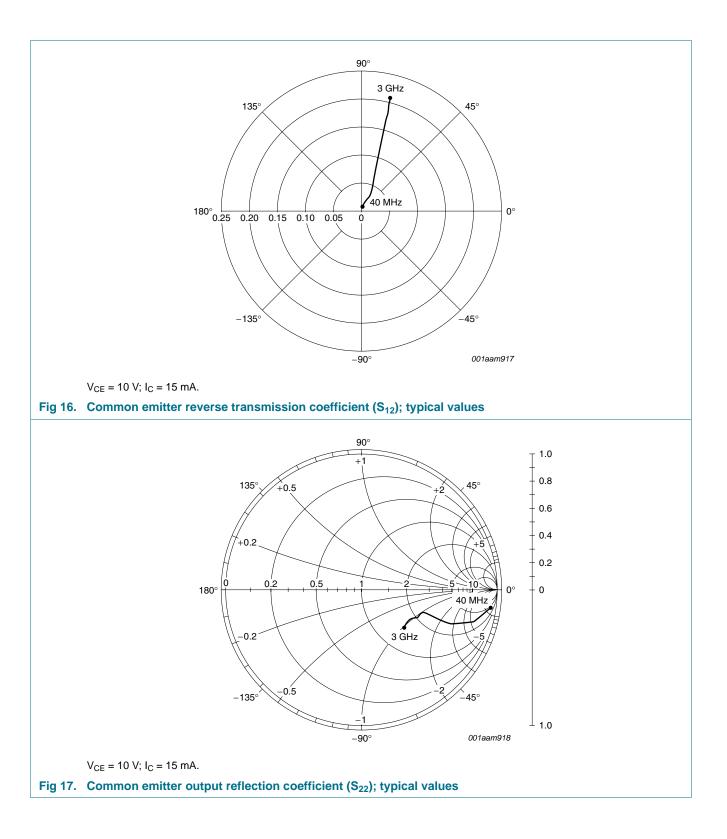
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8. Package outline

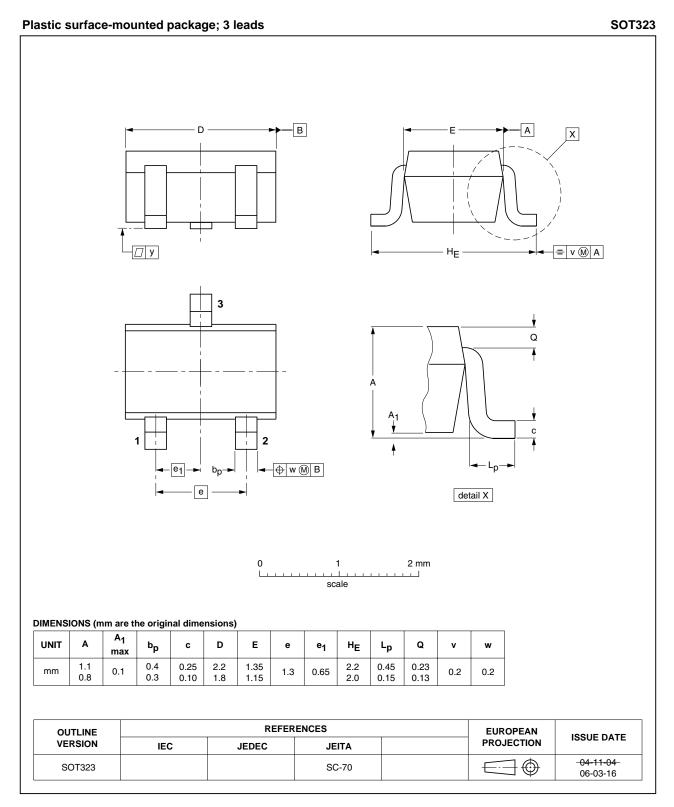


Fig 18. Package outline SOT323

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9. Abbreviations

Table 8. Abbreviations	
Acronym	Description
MSG	Maximum Stable Gain
NPN	Negative Positive Negative
RF	Radio Frequency

10. Revision history

Table 9. Revision	Revision history				
Document ID	Release date	Data sheet status	Change notice	Supersedes	
BFR94AW v.1	20101029	Product data sheet	-	-	

11. Legal information

11.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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[2] The term 'short data sheet' is explained in section "Definitions".

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